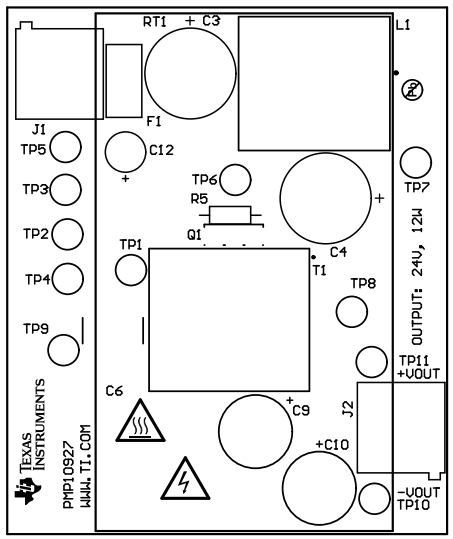
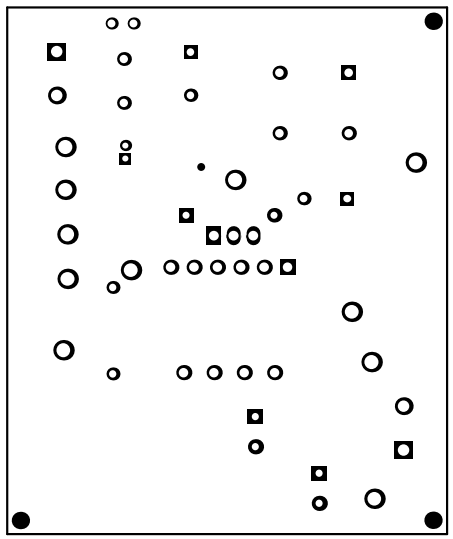
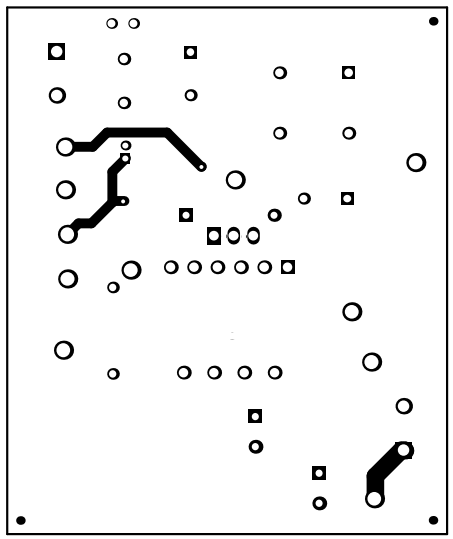


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10927	REV: A	SVN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 2/23/2015 10:40:13 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10927	REV: A	SVN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 2/23/2015 10:40:14 PM		TEXAS INSTRUMENTS

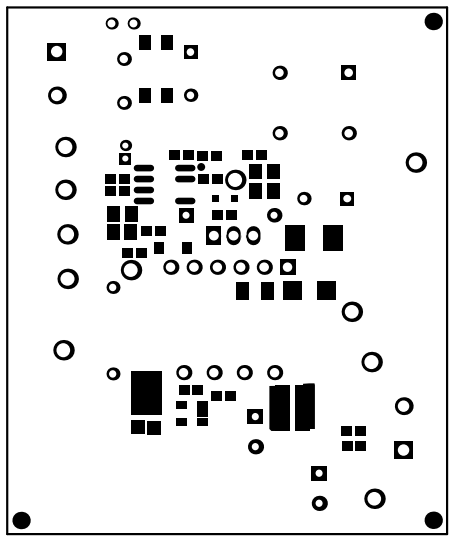


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10927	REV: A	SVN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 2/23/2015 10:40:15 PM		TEXAS INSTRUMENTS

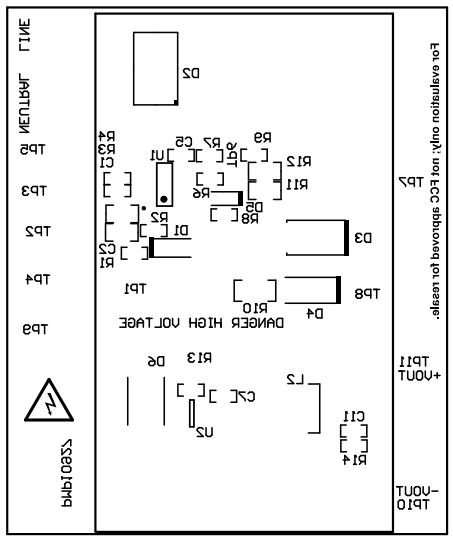
SVN:

Not In VersionControl

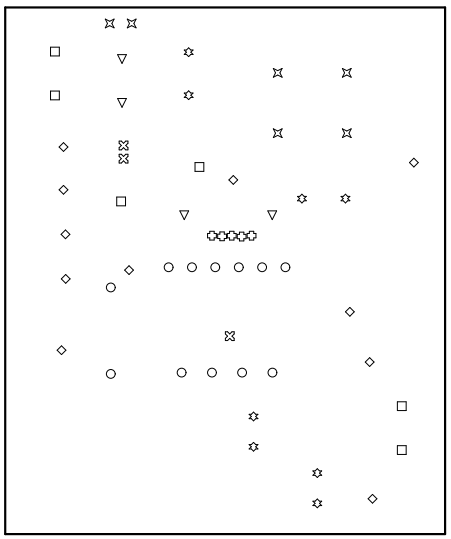
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10927	REV: A	SVN REV: Not In VersionControl	
LAYER NAME = Bottom Layer				
PLOT NAME = Bottom Layer	GENERATED : 2/23/2015 10:40:15 PM			TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10927	REV: A	SVN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 2/23/2015 10:40:16 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10927	REV: A	SVN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 2/23/2015 10:40:17 PM		TEXAS INSTRUMENTS

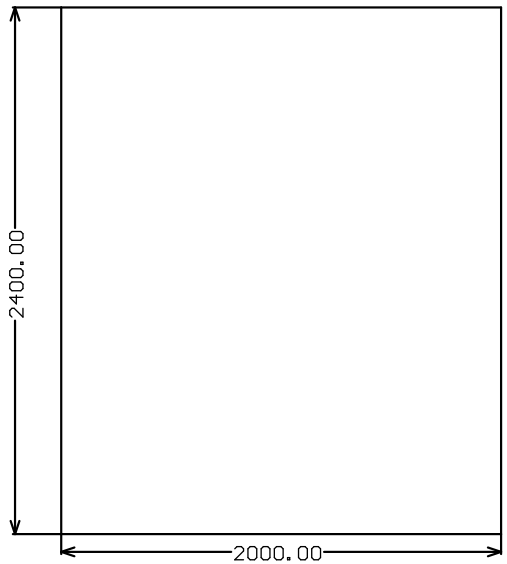


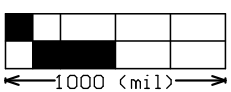
Symbol	Hit Count	Tool Size	Physical Length	Rout Path Length	Plated	Ho
□	2	18mil (0.457mm)			PTH	Rou
⊠	2	27.559mil (0.7mm)			PTH	Rou
▽	2	32mil (0.813mm)			PTH	Rou
✡	4	33mil (0.838mm)			PTH	Rou
○	2	33.465mil (0.85mm)			PTH	Rou
✡	4	35mil (0.889mm)			PTH	Rou
⊠	2	35.433mil (0.9mm)			PTH	Rou
▽	2	37.402mil (0.95mm)			PTH	Rou
⊠	4	39.37mil (1mm)			PTH	Rou
○	10	43.307mil (1.1mm)			PTH	Rou
✡	3	45mil (1.143mm)			PTH	Rou
□	4	51.181mil (1.3mm)			PTH	Rou
◇	11	63mil (1.6mm)			PTH	Rou
✡	2	21mil (0.533mm)	100mil (2.54mm)	79mil (2.007mm)	NPTH	Slo
⊠	1	31mil (0.787mm)	1225mil (31.115mm)	1194mil (30.328mm)	NPTH	Slo
	55 Total					

Slot definitions : **Rout Path Length** = Calculated from tool start centre position to tool end
Physical Length = Rout Path Length + Tool Size = Slot length as defined

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10927	REV: A	SVN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 2/23/2015 10:40:17 PM		TEXAS INSTRUMENTS





ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10927	REV: A	SVN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 2/23/2015 10:40:18 PM		TEXAS INSTRUMENTS

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